



October 2001
Revised October 2001

NC7SB121

TinyLogic™ Low Voltage UHS Single SPST Wide Bandwidth Normally Open Analog Switch

General Description

The NC7SB121 is a ultra high-speed (UHS) CMOS compatible single-pole/single-throw (SPST) analog switch or 1-bit bus switch. The LOW on resistance of the switch allows inputs to be connected to outputs with minimal propagation delay and without generating additional ground bounce noise. The device is organized as a 1-bit switch with a switch enable (OE) signal. When OE is HIGH, the switch is on and Port A is connected to Port B. When OE is LOW, the switch is open and a high-impedance state exists between the two ports.

Features

- Space saving SOT23 or SC70 5-lead package
- Ultra small MicroPak™ leadless package
- Broad V_{CC} Operating Range 2V–5.5V
- Rail-to-rail signal handling
- 7.2Ω switch connection between two ports
- Minimal propagation delay through the switch
- Low I_{CC}
- Zero bounce in flow-through mode
- Control input compatible with CMOS input levels
- >326 MHz –3dB bandwidth
- Improved package replacement for the P15A121

Ordering Code:

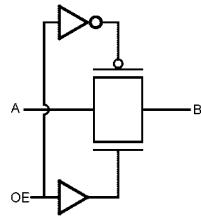
Order Number	Package Number	Product Code Top Mark	Package Description	Supplied As
NC7SB121M5X	MA05B	7B21	5-Lead SOT23, JEDEC MO-178, 1.6mm	3k Units on Tape and Reel
NC7SB121P5X	MAA05A	B21	5-Lead SC70, EIAJ SC-88a, 1.25mm Wide	3k Units on Tape and Reel
NC7SB121L6X	MAC06 (Preliminary)	21	6-Lead MicroPak, 1.0mm Wide	5k Units on Tape and Reel

TinyLogic™ and MicroPak™ are trademarks of Fairchild Semiconductor Corporation.

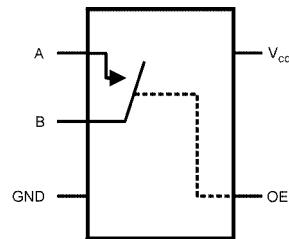
NC7SB121 TinyLogic™ Low Voltage UHS Single SPST Wide Bandwidth Normally Open Analog Switch

NC7SB121

Logic Symbol



Analog Symbol



Pin Descriptions

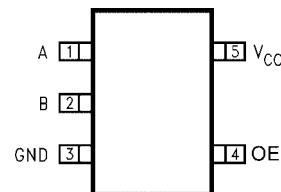
Pin Names	Description
OE	Switch Enable Input
A	Bus A I/O
B	Bus B I/O
NC	No Connect

Function Table

OE	B_0	Function
L	HIGH-Z State	Disconnect
H	A_0	Connect

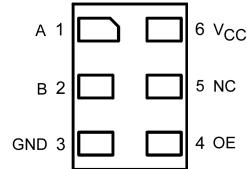
Connection Diagrams

Pin Assignments for SC70



(Top View)

Pad Assignment for MicroPak



(Top Thru View)

Absolute Maximum Ratings(Note 1)

Supply Voltage (V_{CC})	-0.5V to +7.0V
DC Switch Voltage (V_S)	-0.5V to V_{CC} +0.5V
DC Input Voltage (V_{IN}) (Note 2)	-0.5V to +7.0V
DC Input Diode Current (I_{IK}) $V_{IN} < 0V$	-50 mA
DC Output (I_{OUT}) Sink Current	128 mA
DC V_{CC}/GND Current (I_{CC}/I_{GND})	±100 mA
Storage Temperature Range (T_{STG})	-65°C to +150°C
Junction Lead Temperature under Bias (T_J)	+150°C
Junction Lead Temperature (T_L) (Soldering, 10 Seconds)	+260°C
Power Dissipation (P_D) @ +85°C	
SOT23-5	200 mW
SC70-5	150 mW

Recommended Operating Conditions(Note 3)

Power Supply Operating (V_{CC})	2V to 5.5V
Control Input Voltage (V_{IN})	0V to 5.5V
Switch Input Voltage (V_{IN})	0V to V_{CC}
Switch Output Voltage (V_{OUT})	0V to V_{CC}
Input Rise and Fall Time (t_r, t_f)	
Control Input; $V_{CC} = 2.3V\text{--}3.6V$	0 ns/V to 10 ns
Control Input; $V_{CC} = 4.5\text{--}5.5V$	0 ns/V to 5 ns
Switch I/O	0 ns/V to DC
Operating Temperature (T_A)	-40°C to +85°C
Thermal Resistance (θ_{JA})	
SOT23-5	300°C/Watt
SC70-5	425°C/Watt

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 2: The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.

Note 3: Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

Symbol	Parameter	V_{CC} (V)	$T_A = +25^\circ C$			$T_A = -40^\circ C \text{ to } +85^\circ C$			Units	Conditions
			Min	Typ	Max	Min	Typ	Max		
V_{IH}	HIGH Level Input Voltage	2 to 5.5				0.7 V_{CC}			V	
V_{IL}	LOW Level Input Voltage	2 to 5.5					0.3 V_{CC}		V	
I_{IN}	Control Input Leakage Current	0 to 5.5				± 0.05	± 1.0		μA	$0 \leq V_{IN} \leq 5.5V$
I_{OFF}	OFF Leakage Current	2 to 5.5				± 0.05	± 10.0		μA	$0 \leq A, B \leq V_{CC}$
R_{ON} (Note 4)	Switch On Resistance	4.5	7.2	10		12			Ω	$V_{IN} = 2.5V, I_{IN} = 30mA$
		3.0	12	18		12	22			$V_{IN} = 1.5V, I_{IN} = 24mA$
R_{flat} (Note 4)(Note 6)(Note 7)	On Resistance Flatness	5.0	3.2	3.5		4			Ω	$I_A = -30mA, V_{IN} = 1, 2.5, 4V$
		3.3	4.5	5		5				$I_A = -24mA, V_{IN} = 0.8, 2.5V$
I_{CC}	Quiescent Supply Current	2 to 5.5		1		0.05	10		μA	$V_{IN} = V_{CC}$ or GND $I_{OUT} = 0$

Note 4: Measured by the voltage drop between A and B pins at the indicated current through the switch. On Resistance is determined by the lower of the voltages on the two (A or B) pins.

Note 5: All typical values are at the specified V_{CC} , and $T_A = 25^\circ C$.

Note 6: Parameter is characterized but not tested in production.

Note 7: Flatness is defined as the difference between the maximum and minimum value of On Resistance over the specified range of conditions.

AC Electrical Characteristics

Symbol	Parameter	V_{CC} (V)	$T_A = -40^\circ C$ to $+85^\circ C$, $C_L = 50 \text{ pF}$, $R_U = R_D = 500\Omega$			Units	Conditions	Figure Number
			Min	Typ (Note 8)	Max			
t_{PZL}, t_{PZH}	Output Enable Time	3.0 - 3.6		25	ns	$V_{IN} = 2 \times V_{CC}$ for t_{PZL} $V_{IN} = 0V$ for t_{PZH}	Figures 1, 2	
		4.5 - 5.5		15	ns			
t_{PLZ}, t_{PHZ}	Output Disable Time	3.0 - 3.6		12	ns	$V_{IN} = 2 \times V_{CC}$ for t_{PLZ} $V_{IN} = 0V$ for t_{PHZ}	Figures 1, 2	
		4.5 - 5.5		7	ns			
Q	Charge Injection (Note 9)	2 - 5.5		10	pC	$C_L = 1 \text{ nF}$, $V_{GEN} = 0V$, $R_{GEN} = 0\Omega$, $f = 1 \text{ MHz}$	Figure 3	
OIRR	Off Isolation (Note 10)	2 - 5.5		-43	dB	$R_L = 50 \Omega$, $C_L = 5 \text{ pF}$, $f = 10 \text{ MHz}$	Figure 4	
BW	-3dB Bandwidth	2 - 5.5		326	MHz	$R_L = 50 \Omega$	Figure 5	

Note 8: All typical values are at the specified V_{CC} , and $T_A = 25^\circ C$.

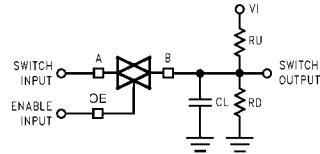
Note 9: Guaranteed by design.

Note 10: Off Isolation = $20 \log_{10} [V_A/V_{BN}]$.

Capacitance

Symbol	Parameter	Typ	Max	Units	Conditions
C_{IN}	Control Pin Input Capacitance	2		pF	$V_{CC} = 0V$
C_{IO}	Input/Output Capacitance	5.5		pF	$V_{CC} = 5.0V$

AC Loading and Waveforms



Input driven by 50Ω source terminated in 50Ω

C_L includes load and stray capacitance.

Input PRR = 1.0 MHz; t_w = 500 ns

FIGURE 1. AC Test Circuit

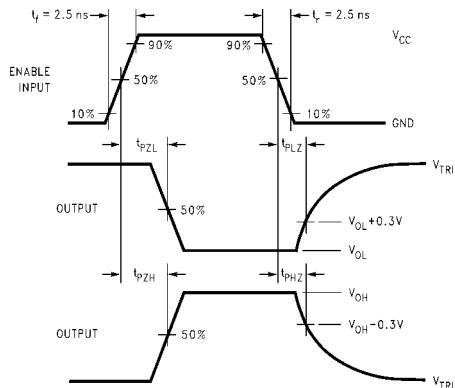
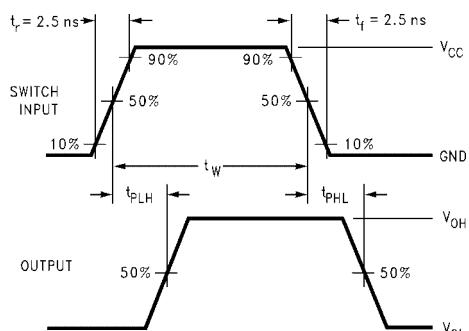


FIGURE 2. AC Waveforms

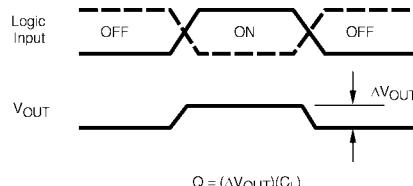
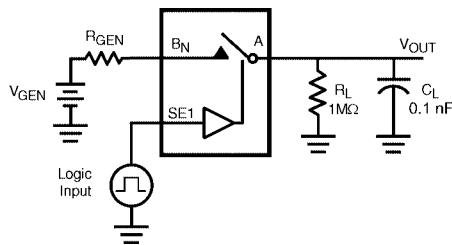


FIGURE 3. Charge Injection Test

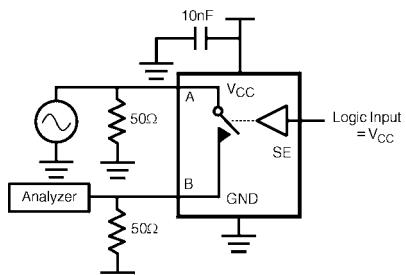


FIGURE 4. Off Isolation

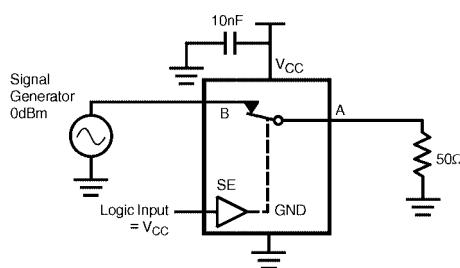


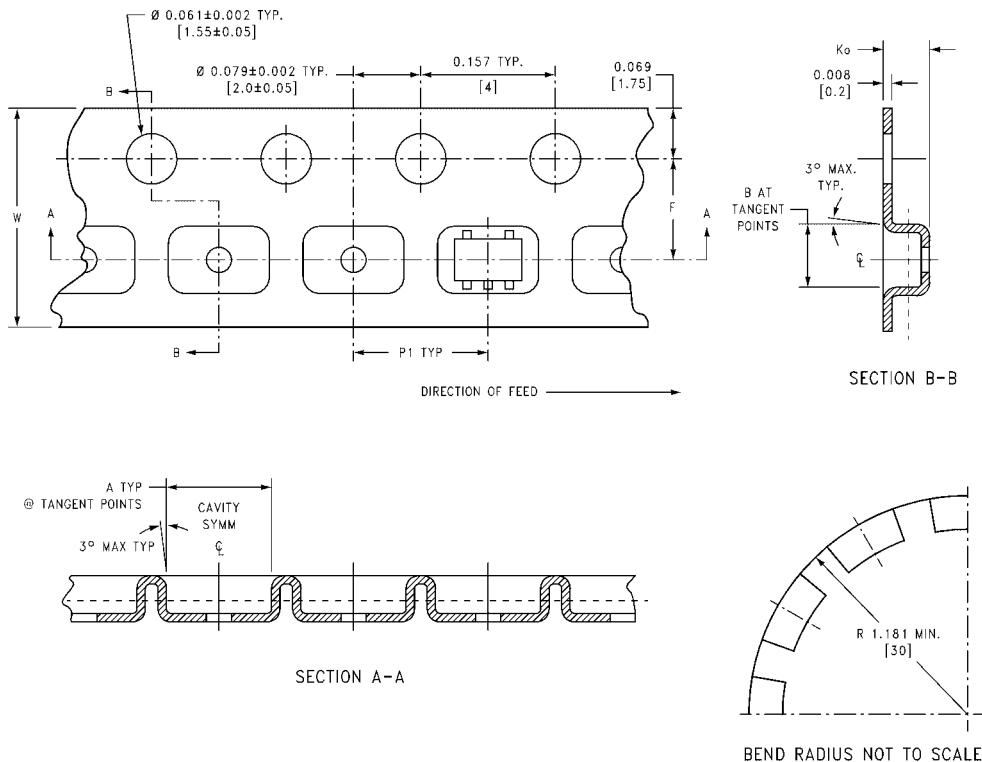
FIGURE 5. Bandwidth

Tape and Reel Specification

TAPE FORMAT FOR SOT23, SC70

Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status
M5X, P5X	Leader (Start End)	125 (typ)	Empty	Sealed
	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

TAPE DIMENSIONS inches (millimeters)



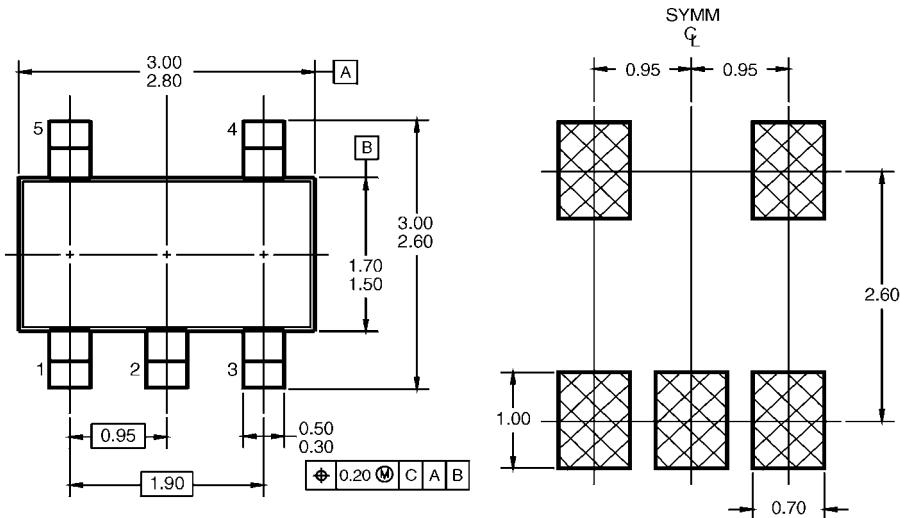
Package	Tape Size	DIM A	DIM B	DIM F	DIM K _o	DIM P1	DIM W
SC70-5	8 mm	0.093 (2.35)	0.096 (2.45)	0.138 ± 0.004 (3.5 ± 0.10)	0.053 ± 0.004 (1.35 ± 0.10)	0.157 (4)	0.315 ± 0.004 (8 ± 0.1)
SOT23-5	8 mm	0.130 (3.3)	0.130 (3.3)	0.138 ± 0.002 (3.5 ± 0.05)	0.055 ± 0.004 (1.4 ± 0.11)	0.157 (4)	0.315 ± 0.012 (8 ± 0.3)

Tape and Reel Specification (Continued)
TAPE FORMAT FOR MicroPak

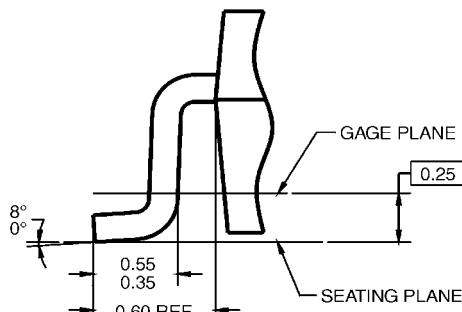
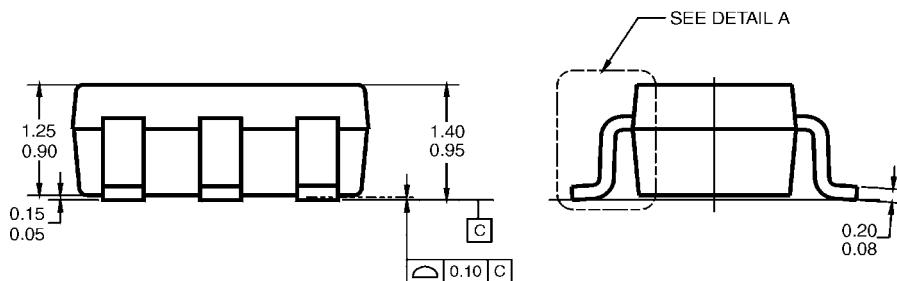
Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status				
L6X	Leader (Start End) Carrier Trailer (Hub End)	125 (typ) 5000 75 (typ)	Empty Filled Empty	Sealed Sealed Sealed				
TAPE DIMENSIONS inches (millimeters)								
<u>SECTION A-A</u> SCALE:10X								
<u>SECTION B-B</u> SCALE:10X								
REEL DIMENSIONS inches (millimeters)								
<u>DETAIL X</u> <u>DETAIL X</u> SCALE: 3X								
Tape Size	A	B	C	D	N	W1	W2	W3
8 mm	7.0 (177.8)	0.059 (1.50)	0.512 (13.00)	0.795 (20.20)	2.165 (55.00)	0.331 + 0.059/-0.000 (8.40 + 1.50/-0.00)	0.567 (14.40)	W1 + 0.078/-0.039 (W1 + 2.00/-1.00)

NC7SB121

Physical Dimensions inches (millimeters) unless otherwise noted



LAND PATTERN RECOMMENDATION



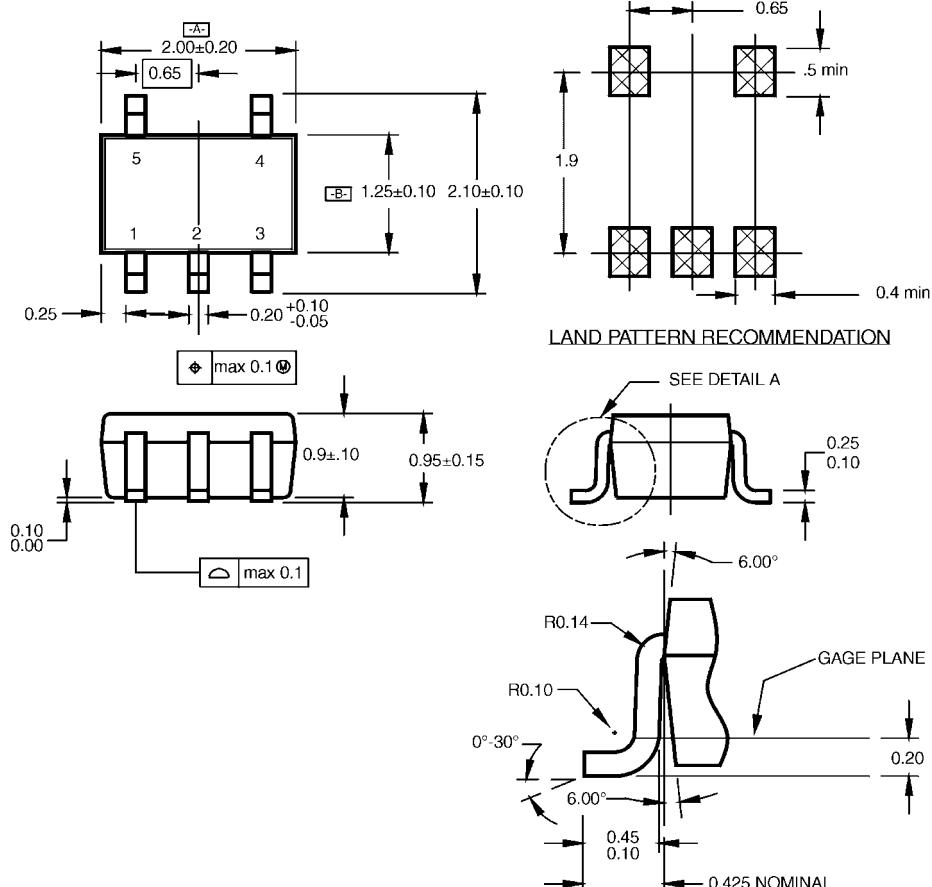
NOTES: UNLESS OTHERWISE SPECIFIED
A) THIS PACKAGE CONFORMS TO JEDEC
MO-178, ISSUE B, VARIATION AA,
DATED JANUARY 1999.
B) ALL DIMENSIONS ARE IN MILLIMETERS.

MA05BRevC

DETAIL A

5-Lead SOT23, JEDEC MO-178, 1.6mm
Package Number MA05B

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

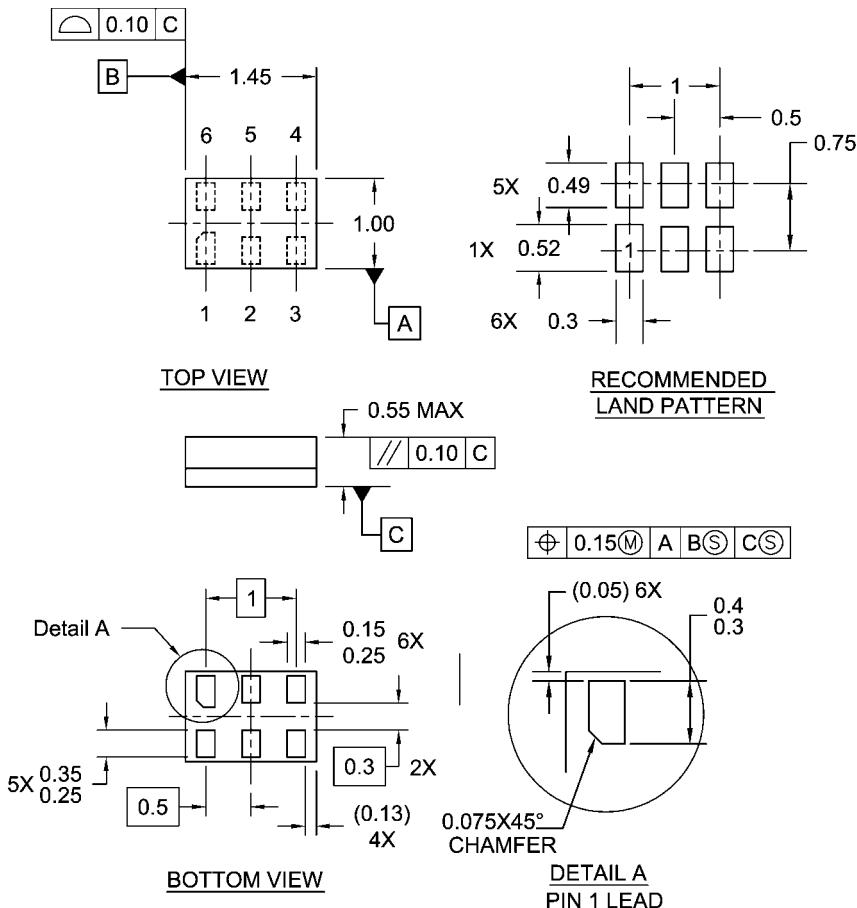


NOTES:

- A. CONFORMS TO EIAJ REGISTERED OUTLINE DRAWING SC88A.
- B. DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH.
- C. DIMENSIONS ARE IN MILLIMETERS.

MAA05ARevC

5-Lead SC70, EIAJ SC-88a, 1.25mm Wide
Package Number MAA05A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

Notes:

1. JEDEC PACKAGE REGISTRATION IS ANTICIPATED
2. DIMENTIONS ARE IN MILLIMETERS
3. THIS DRAWING IS PRELIMINARY AND SUBJECT TO CHANGE
4. DRAWING CONFORMS TO ASME Y14.5M-1994

MAC06ARevB

**6-Lead MicroPak, 1.0mm Wide
Package Number MAC06A**
Preliminary

Fairchild does not assume any responsibility for use of any circuitry described, no circuit patent licenses are implied and Fairchild reserves the right at any time without notice to change said circuitry and specifications.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

www.fairchildsemi.com